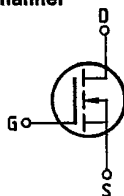


## SIEMENS AKTIENGESELLSCHAFT

## Main ratings

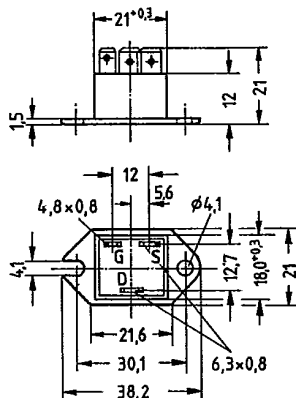
|                            |              |                |
|----------------------------|--------------|----------------|
| Drain-source voltage       | $V_{DS}$     | = 1000 V       |
| Continuous drain current   | $I_D$        | = 3,6 A        |
| Drain-source on-resistance | $R_{DS(on)}$ | = 2,6 $\Omega$ |

N-Channel



**Description** SIPMOS, N-channel, enhancement mode  
**Case** Plastic package TO 238 AA with insulated metal base plate in accordance with JEDEC, compatible with TO 3; AMP plug-in connections.  
 Approx. weight 21 g

| Type     | Ordering code   |
|----------|-----------------|
| BUZ 58 A | C67078-A1607-A3 |



## Maximum ratings

Dimensions in mm

| Description                             | Symbols       | Ratings      | Units             | Conditions                        |
|-----------------------------------------|---------------|--------------|-------------------|-----------------------------------|
| Drain-source voltage                    | $V_{DS}$      | 1000         | V                 |                                   |
| Drain-gate voltage                      | $V_{DGR}$     | 1000         | V                 | $R_{GS} = 20 \text{ k}\Omega$     |
| Continuous drain current                | $I_D$         | 3,6          | A                 | $T_C = 30 \text{ }^\circ\text{C}$ |
| Pulsed drain current                    | $I_{D(puls)}$ | 14           | A                 | $T_C = 25 \text{ }^\circ\text{C}$ |
| Gate-source voltage                     | $V_{GS}$      | $\pm 20$     | V                 |                                   |
| Max. power dissipation                  | $P_D$         | 83,3         | W                 | $T_C = 25 \text{ }^\circ\text{C}$ |
| Operating and storage temperature range | $T_T$         | -40 ... +150 | $^\circ\text{C}$  |                                   |
| Isolation test voltage                  | $V_{is}$      | 3500         | Vdc <sup>1)</sup> | $t = 1 \text{ min}$               |
| DIN humidity category                   |               | F            | -                 | DIN 40040                         |
| IEC climatic category                   |               | 40/150/56    | -                 | DIN IEC 68-1                      |

## Thermal resistance

|             |            |            |     |
|-------------|------------|------------|-----|
| Chip - case | $R_{thJC}$ | $\leq 1,5$ | K/W |
|-------------|------------|------------|-----|

<sup>1)</sup> Isolation test voltage between drain and base plate referred to standard climate 23/50 in accordance with DIN 50014.

## Electrical characteristics

(at  $T_j = 25^\circ\text{C}$  unless otherwise specified)

| Description                     | Symbol        | Characteristics |      |      | Unit          | Conditions                                                                                               |
|---------------------------------|---------------|-----------------|------|------|---------------|----------------------------------------------------------------------------------------------------------|
|                                 |               | min.            | typ. | max. |               |                                                                                                          |
| Drain-source breakdown voltage  | $V_{(BR)DSS}$ | 1000            | —    | —    | V             | $V_{GS} = 0\text{V}$<br>$I_D = 0,25\text{mA}$                                                            |
| Gate threshold voltage          | $V_{GS(th)}$  | 2,1             | 3,0  | 4,0  |               | $V_{DS} = V_{GS}$<br>$I_D = 1\text{mA}$                                                                  |
| Zero gate voltage drain current | $I_{DSS}$     | —               | 20   | 250  | $\mu\text{A}$ | $T_j = 25^\circ\text{C}$<br>$T_j = 125^\circ\text{C}$<br>$V_{DS} = 1000\text{V}$<br>$V_{GS} = 0\text{V}$ |
| Gate-source leakage current     | $I_{GSS}$     | —               | 10   | 100  | nA            | $V_{GS} = 20\text{V}$<br>$V_{DS} = 0\text{V}$                                                            |
| Drain-source on-resistance      | $R_{DS(on)}$  | —               | 2,3  | 2,6  | $\Omega$      | $V_{GS} = 10\text{V}$<br>$I_D = 2,6\text{A}$                                                             |

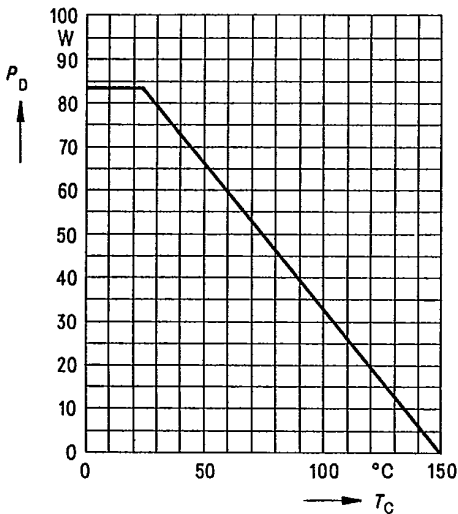
## Dynamic ratings

|                                                             |              |     |     |     |    |                                                                                              |
|-------------------------------------------------------------|--------------|-----|-----|-----|----|----------------------------------------------------------------------------------------------|
| Forward transconductance                                    | $g_{fs}$     | 1,4 | 3,5 | —   | S  | $V_{DS} = 25\text{V}$<br>$I_D = 2,6\text{A}$                                                 |
| Input capacitance                                           | $C_{iss}$    | —   | 3,9 | 5,0 | nF | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$                           |
| Output capacitance                                          | $C_{oss}$    | —   | 180 | 300 | pF |                                                                                              |
| Reverse transfer capacitance                                | $C_{rss}$    | —   | 70  | 120 |    |                                                                                              |
| Turn-on time $t_{on}$<br>( $t_{on} = t_{d(on)} + t_r$ )     | $t_{d(on)}$  | —   | 60  | 90  | ns | $V_{CC} = 30\text{V}$<br>$I_D = 2,4\text{A}$<br>$V_{GS} = 10\text{V}$<br>$R_{GS} = 50\Omega$ |
|                                                             | $t_r$        | —   | 90  | 140 |    |                                                                                              |
| Turn-off time $t_{off}$<br>( $t_{off} = t_{d(off)} + t_f$ ) | $t_{d(off)}$ | —   | 330 | 430 |    |                                                                                              |
|                                                             | $t_f$        | —   | 110 | 140 |    |                                                                                              |

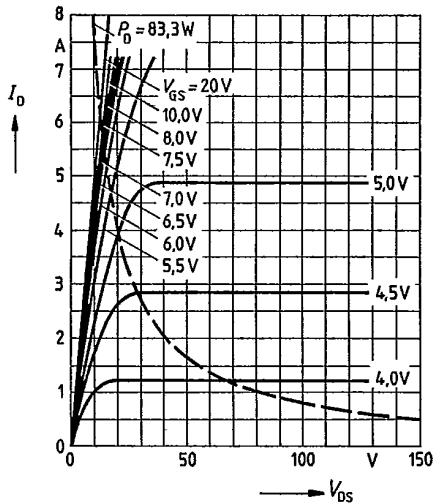
## Reverse diode

|                                  |           |   |      |     |               |                                                                              |
|----------------------------------|-----------|---|------|-----|---------------|------------------------------------------------------------------------------|
| Continuous reverse drain current | $I_{DR}$  | — | —    | 3,6 | A             | $T_C = 25^\circ\text{C}$                                                     |
| Pulsed reverse drain current     | $I_{DRM}$ | — | —    | 14  |               |                                                                              |
| Diode forward on-voltage         | $V_{SD}$  | — | 1,1  | 1,4 | V             | $I_F = 2 \times I_{DR}$<br>$V_{GS} = 0\text{V}$ , $T_j = 25^\circ\text{C}$   |
| Reverse recovery time            | $t_{rr}$  | — | 2000 | —   | ns            | $T_j = 25^\circ\text{C}$                                                     |
| Reverse recovery charge          | $Q_{rr}$  | — | 30   | —   | $\mu\text{C}$ | $I_F = I_{DR}$<br>$dI_F/dt = 100\text{A}/\mu\text{s}$<br>$V_R = 100\text{V}$ |

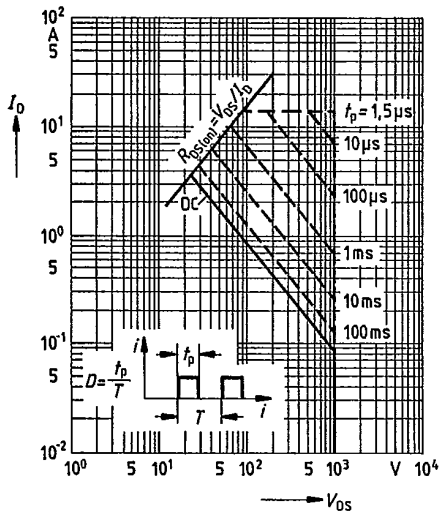
Power dissipation  $P_D = f(T_C)$



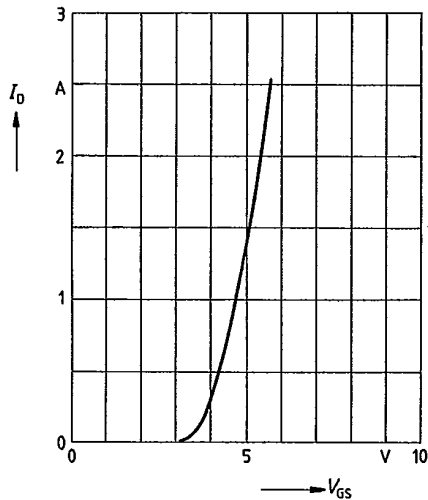
Typical output characteristics  $I_D = f(V_{DS})$   
parameter: 80  $\mu\text{s}$  pulse test,  
 $T_J = 25^{\circ}\text{C}$



Safe operating area  $I_D = f(V_{DS})$   
parameter:  $D = 0.01$ ,  $T_C = 25^{\circ}\text{C}$



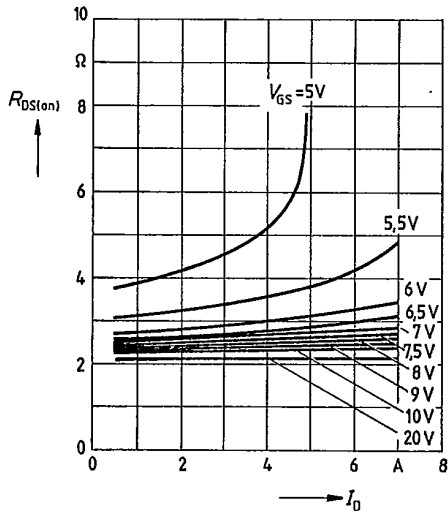
Typical transfer characteristic  $I_D = f(V_{GS})$   
parameter: 80  $\mu\text{s}$  pulse test,  
 $V_{DS} = 25\text{ V}$ ,  $T_J = 25^{\circ}\text{C}$



**Typical drain-source on-state resistance**

$R_{DS(on)} = f(I_D)$

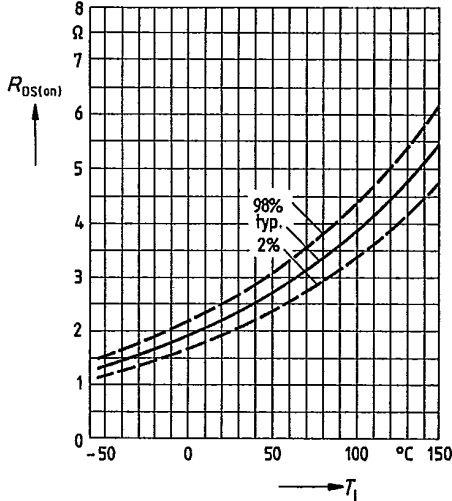
parameter:  $V_{GS}$ ;  $T_j = 25^\circ\text{C}$



**Drain-source on-state resistance**

$R_{DS(on)} = f(T_j)$

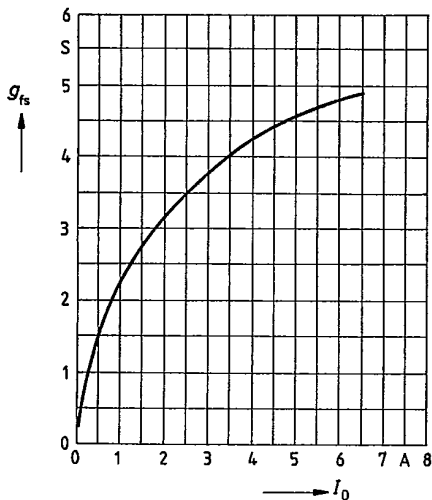
parameter:  $I_D = 2.6\text{A}$ ,  $V_{GS} = 10\text{V}$  (spread)



**Typical transconductance  $g_{fs} = f(I_D)$**

parameter:  $80\ \mu\text{s}$  pulse test,

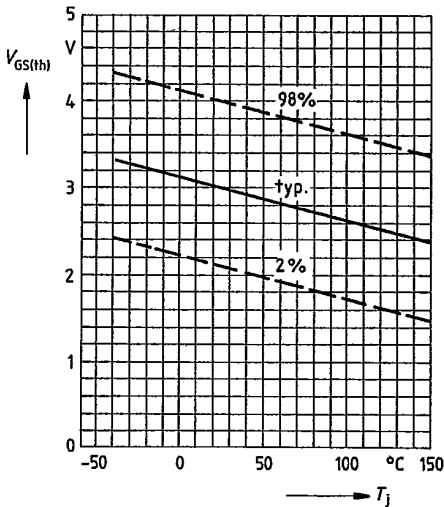
$V_{DS} = 25\text{V}$ ,  $T_j = 25^\circ\text{C}$



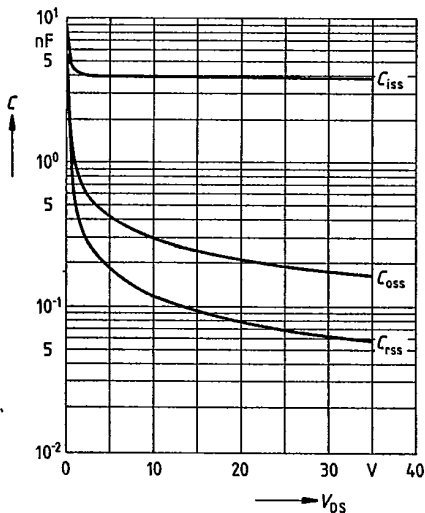
**Gate threshold voltage  $V_{GS(th)} = f(T_j)$**

parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1\text{mA}$

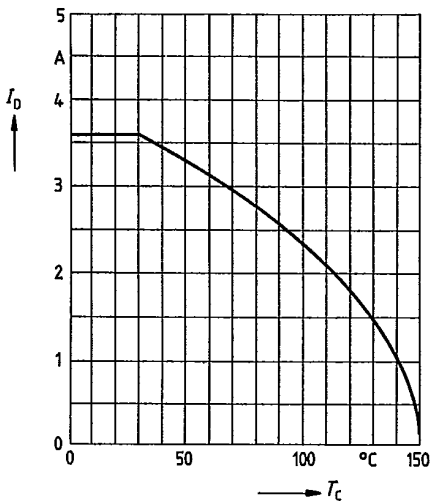
(spread)



Typical capacitances  $C = f(V_{DS})$   
 parameter:  $V_{GS} = 0$ ,  $f = 1\text{MHz}$

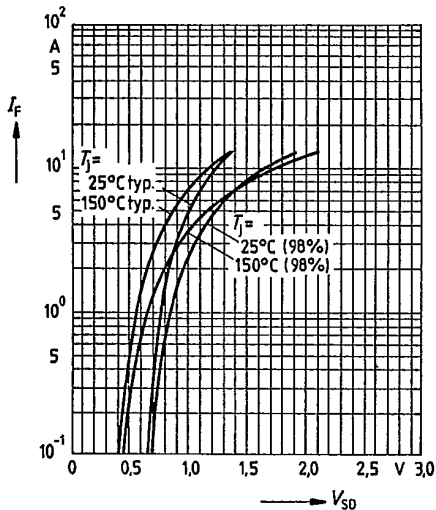


Continuous drain current  $I_D = f(T_C)$   
 parameter:  $V_{GS} \geq 10\text{V}$

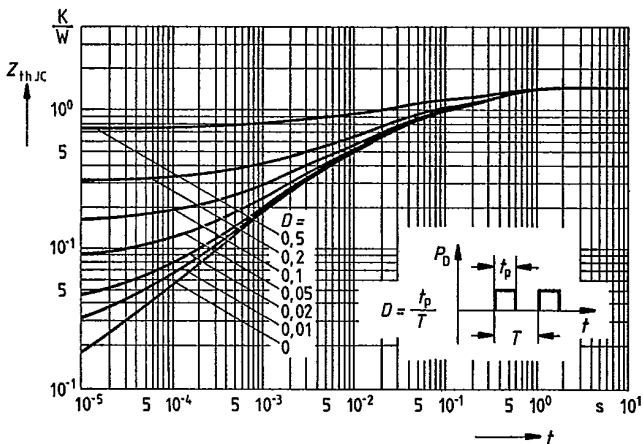


Forward characteristic of reverse diode

$I_F = f(V_{SD})$   
 parameter:  $T_J$ ,  $t_p = 80 \mu\text{s}$   
 (spread)



**Transient thermal impedance  $Z_{thJC} = f(t)$**   
 parameter:  $D = t_p/T$



**Typical gate-charge  $V_{GS} = f(Q_{Gate})$**   
 parameter:  $I_{D\ puls} = 8A$

